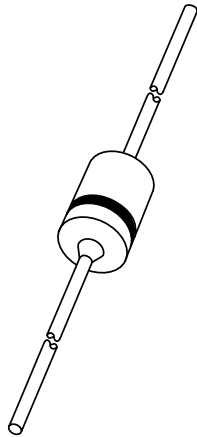


# DATA SHEET



## **BAW62** High-speed diode

Product specification  
Supersedes data of April 1996

1996 Sep 17

High-speed diode

BAW62

FEATURES

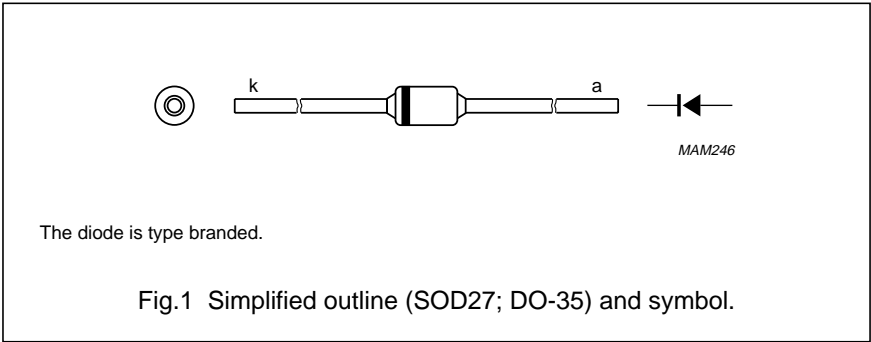
- Hermetically sealed leaded glass SOD27 (DO-35) package
- High switching speed: max. 4 ns
- Continuous reverse voltage: max. 75 V
- Repetitive peak reverse voltage: max. 75 V
- Repetitive peak forward current: max. 450 mA.

APPLICATIONS

- High-speed switching
- Fast logic applications.

DESCRIPTION

The BAW62 is a high-speed switching diode fabricated in planar technology, and encapsulated in the hermetically sealed leaded glass SOD27 (DO-35) package.



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>RRM</sub>	repetitive peak reverse voltage		–	75	V
V <sub>R</sub>	continuous reverse voltage		–	75	V
I <sub>F</sub>	continuous forward current	see Fig.2; note 1	–	250	mA
I <sub>FRM</sub>	repetitive peak forward current		–	450	mA
I <sub>FSM</sub>	non-repetitive peak forward current	square wave; T <sub>j</sub> = 25 °C prior to surge; see Fig.4			
		t = 1 μs	–	4	A
		t = 1 ms	–	1	A
		t = 1 s	–	0.5	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C; note 1	–	350	mW
T <sub>stg</sub>	storage temperature		–65	+200	°C
T <sub>j</sub>	junction temperature		–	200	°C

Note

1. Device mounted on an FR4 printed circuit-board; lead length 10 mm.

## High-speed diode

## BAW62

**ELECTRICAL CHARACTERISTICS** $T_j = 25\text{ }^{\circ}\text{C}$ ; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_F$	forward voltage	see Fig.3 $I_F = 5\text{ mA}$ $I_F = 100\text{ mA}$ $I_F = 100\text{ mA}; T_j = 100\text{ }^{\circ}\text{C}$	620 – –	750 1000 930	mV mV mV
$I_R$	reverse current	see Fig.5 $V_R = 20\text{ V}$ $V_R = 50\text{ V}$ $V_R = 75\text{ V}$ $V_R = 20\text{ V}; T_j = 150\text{ }^{\circ}\text{C}$ $V_R = 75\text{ V}; T_j = 150\text{ }^{\circ}\text{C}$	– – – – –	25 200 5 50 100	nA nA $\mu\text{A}$ $\mu\text{A}$ $\mu\text{A}$
$C_d$	diode capacitance	$f = 1\text{ MHz}; V_R = 0$ ; see Fig.6	–	2	pF
$t_{rr}$	reverse recovery time	when switched from $I_F = 10\text{ mA}$ to $I_R = 10\text{ mA}$ ; $R_L = 100\text{ }\Omega$ ; measured at $I_R = 1\text{ mA}$ ; see Fig.7	–	4	ns
$V_{fr}$	forward recovery voltage	when switched from $I_F = 50\text{ mA}$ ; $t_r = 20\text{ ns}$ ; see Fig.8	–	2.5	V

**THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-tp}$	thermal resistance from junction to tie-point	lead length 10 mm	240	K/W
$R_{th\ j-a}$	thermal resistance from junction to ambient	lead length 10 mm; note 1	500	K/W

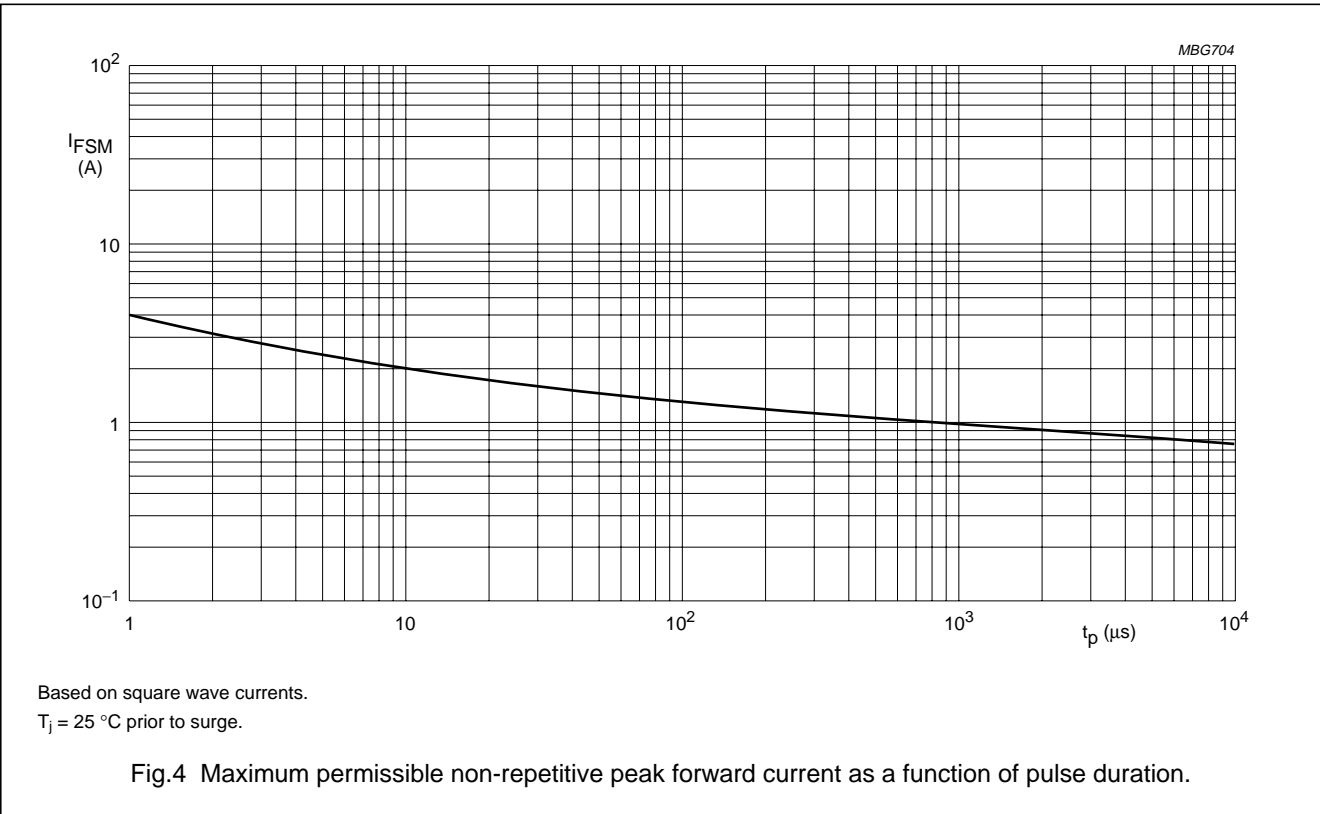
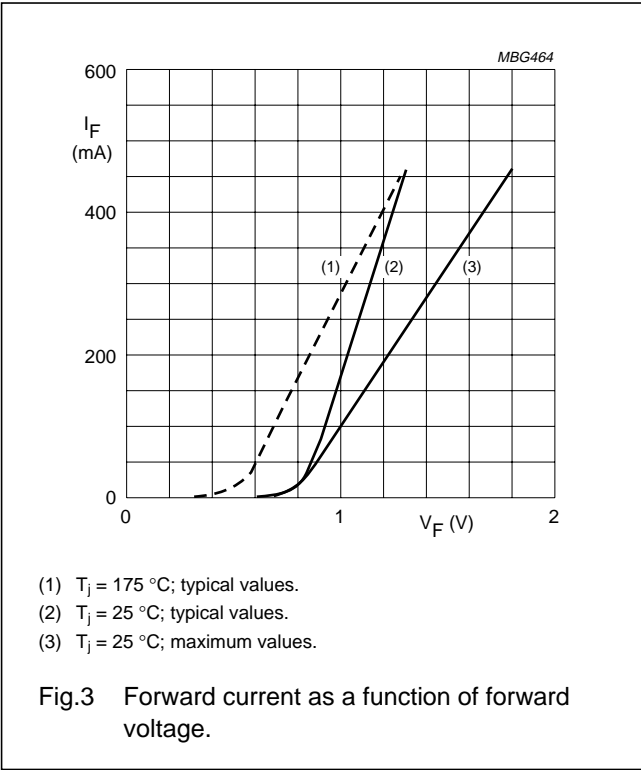
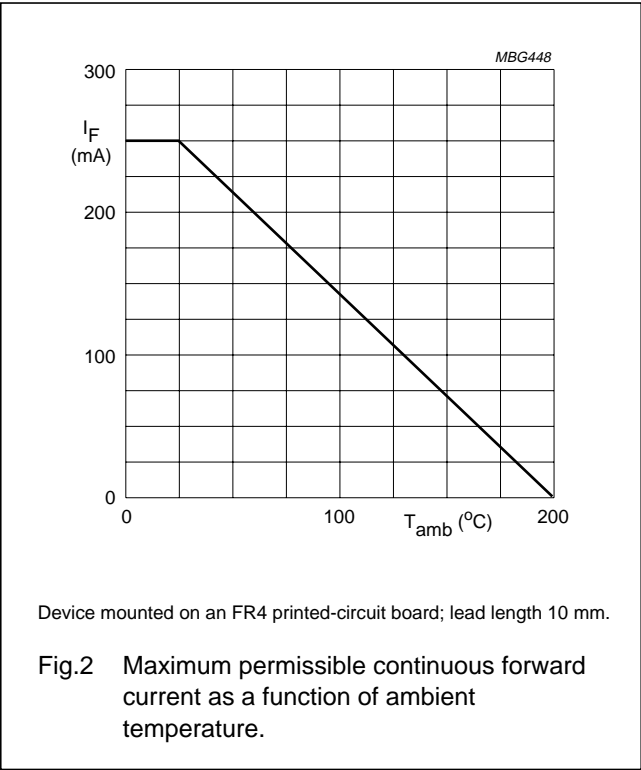
**Note**

1. Device mounted on a printed circuit-board without metallization pad.

High-speed diode

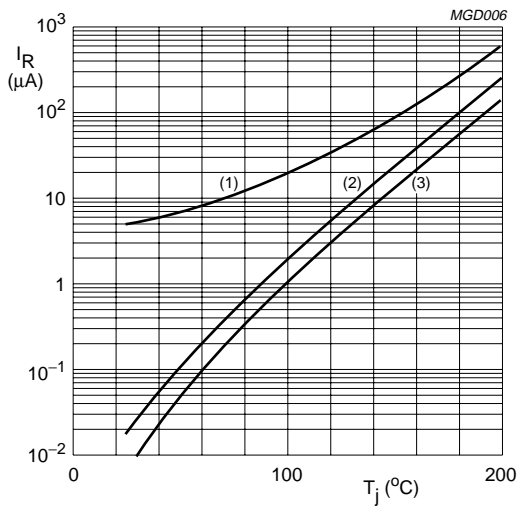
BAW62

GRAPHICAL DATA



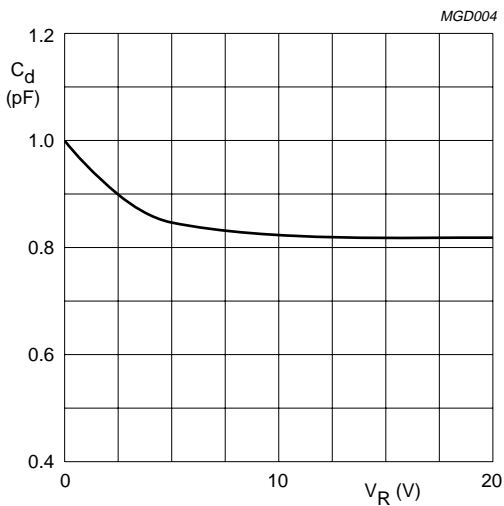
High-speed diode

BAW62



- (1)  $V_R = 75 V$ ; maximum values.
- (2)  $V_R = 75 V$ ; typical values.
- (3)  $V_R = 20 V$ ; typical values.

Fig.5 Reverse current as a function of junction temperature.

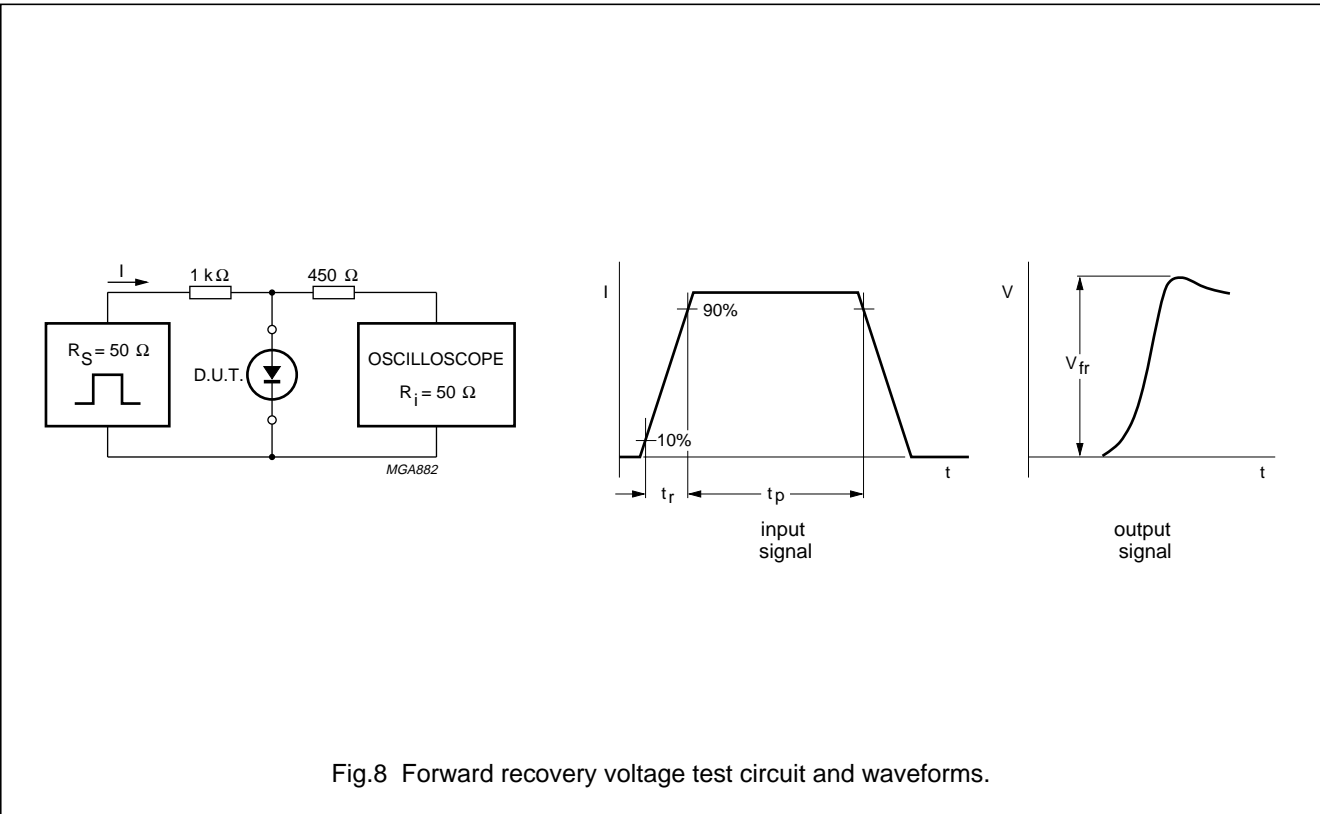
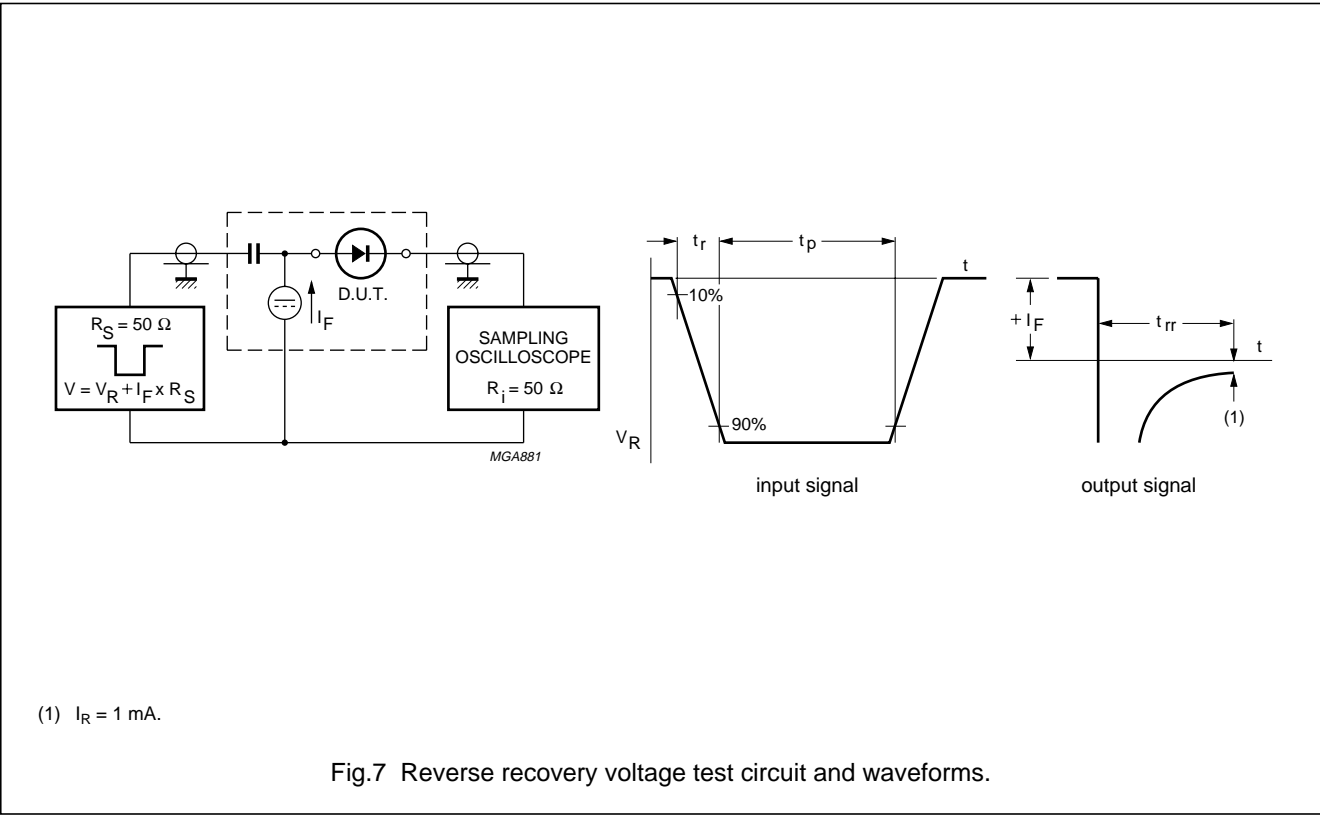


$f = 1 MHz$ ;  $T_j = 25^{\circ}C$ .

Fig.6 Diode capacitance as a function of reverse voltage; typical values.

High-speed diode

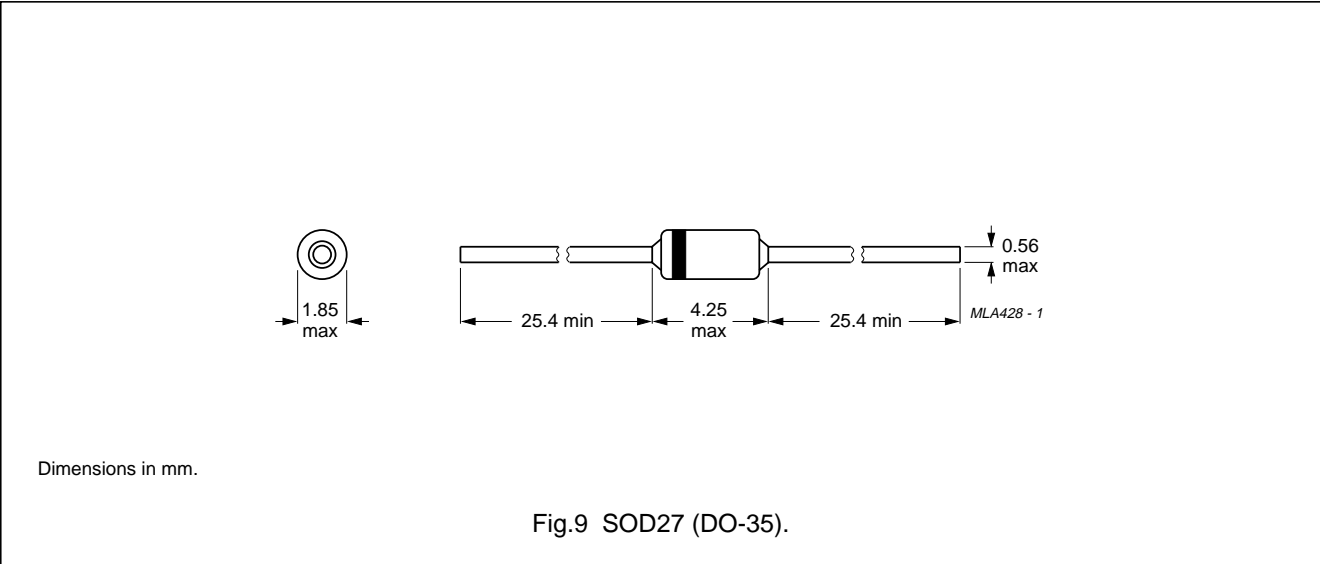
BAW62



High-speed diode

BAW62

PACKAGE OUTLINE



DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.